

CT Micro

Features

- High isolation 5000 VRMS
- Peak Breakdown Voltage
 - 250V CT303X
 - 400V CT304X
 - 600V CT306X
 - 800V CT308X
- Temperature range 55 °C to 100 °C

Applications

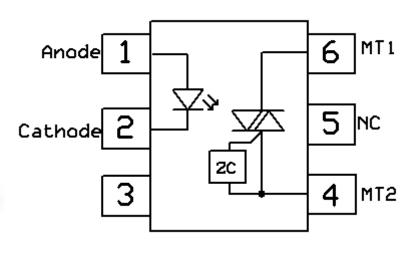
- Motor Controls
- Lamp ballasts
- Static AC Power Switch
- Solenoid/ Valve Control

Description

The CT303X, CT304X, CT306X and CT308X series consists of a Zero Cross Photo Triac optically coupled to a gallium arsenide Infrared-emitting diode in a 6-lead DIP package with bending options.

Package Outline

Schematic



Note: Different bending options available. See package dimension.



Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes	
Viso	Isolation voltage	5000	V _{RMS}		
Topr	Operating temperature		-55 ~ +100	°C	
Тѕтс	Storage temperature		-55 ~ +125	°C	
Tsol	Soldering temperature		260	°C	
Emitter				•	
I _F	Forward current	60	mA		
I _{F(TRANS)}	Peak transient current (≤1µs P.W,300pps)	1 A			
V _R	Reverse voltage	6	V		
P _D	Power dissipation	100	mW		
Detector				•	
P _D	Power dissipation	300	mW		
			250	V	
V	V _{DRM} Off-State Output Terminal Voltage	CT304X	400	V	
V DRM		CT306X	600	V	
		CT308X	800	V	
I _{TSM}	Peak Repetitive Surge Current	1	А		



Electrical Characteristics $T_A = 25$ °C (unless otherwise specified)

Emitter Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	I _F =10mA		1.2	1.4	V	
I _R	Reverse Current	V _R = 6V	-	-	5	μΑ	
Cin	Input Capacitance	f= 1MHz	-	45	-	pF	

Detector Characteristics

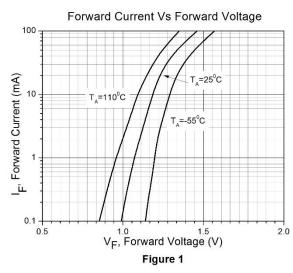
Symbol	Parameters		Test Conditions	Min	Тур	Max	Units	Notes
	Dook Diodeine	CT303X,		-	-	100		
I _{DRM1}	Peak Blocking	CT304X	I _F = 0mA, V _{DRM} = Rated V _{DRM}				nA	
	Current	CT306X,	O ,	-	-	500		
		CT308X						
١.	Inhihit Lookogo Curro	n t	I _F = Rated I _{FT} , V _{DRM} = Rated			500	^	
I _{DRM2}	Inhibit Leakage Curre	ent.	V _{DRM}			500	μΑ	
V _{TM}	Peak On-State Voltage		I _F = Rated I _{FT} , I _{TM} = 100mA	-	•	3	V	
	Critical Rate of Rise	CT303X,						
dv/dt	off-State Voltage	CT304X,	VPEAK= Rated VDRM	1000	-	-)// -	
		CT306X					V/μs	
		CT308X	V _{PEAK} = 400V	600	-	-		

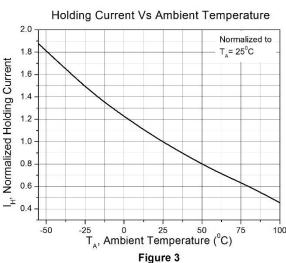
Transfer Characteristics

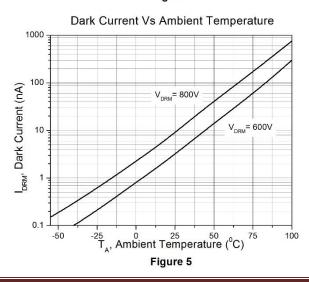
Symbol	Parameters		Test Conditions	Min	Тур	Мах	Units	Notes
	lanut	CT3031, CT3041,	Terminal Voltage = 3V	-	-	15		
		Ct3061, CT3081						
I _{FT}	Input Trigger	CT3032, CT3042,		-	-	10	V	
IF1	Current	CT3062, CT3082					V	
	Current	CT3033, CT3043,		-	-	5		
		CT3063, CT3083						
lн	Holding Current			-	270	-	μΑ	
Rıo	Isolation Resistance		V _{IO} = 500V _{DC}	1x10 ¹¹			Ω	
C _{IO}	Isolation Capacitance		f= 1Mhz		0.25		pF	

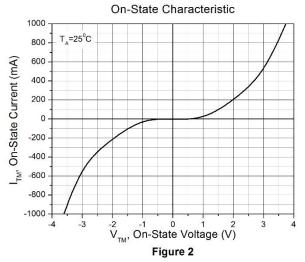


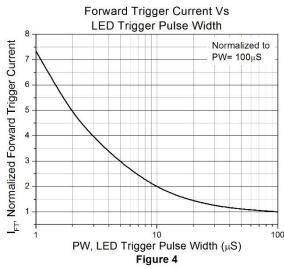
Typical Characteristic Curves

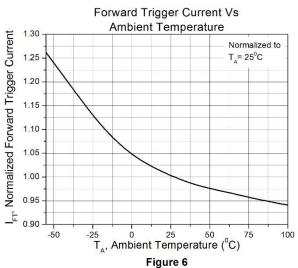






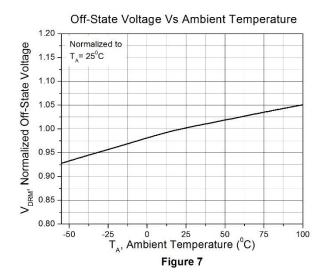


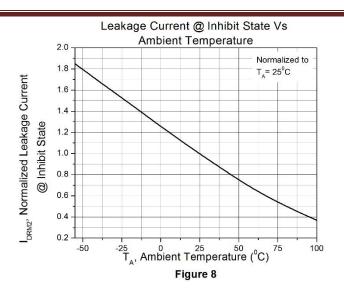


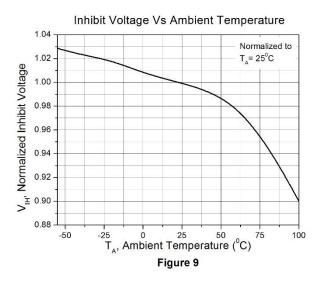




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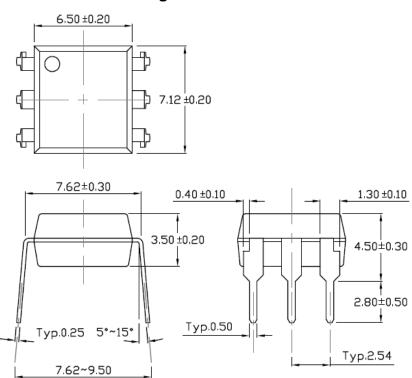




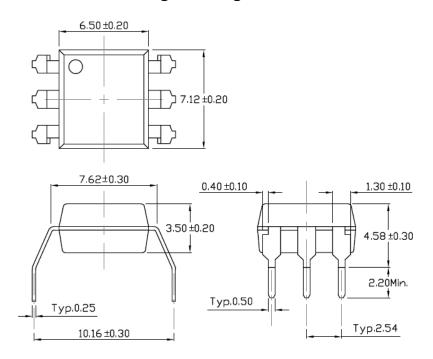


Package Dimension Dimensions in mm unless otherwise stated

Standard DIP - Through Hole

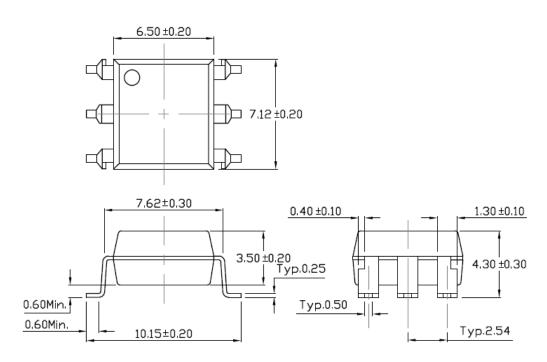


Wide Lead Forming - Through Hole

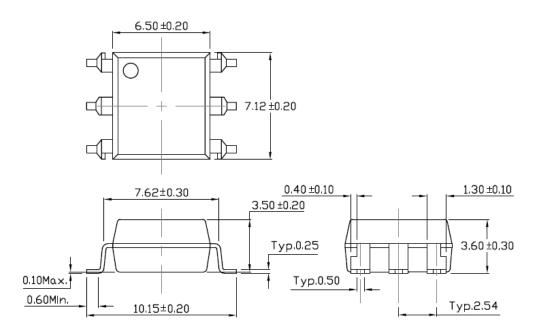




Surface Mount Forming

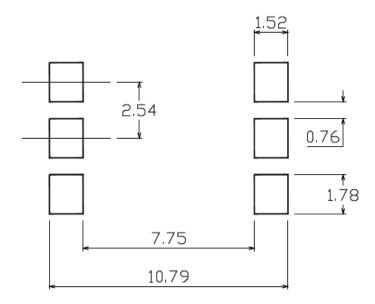


Surface Mount Forming (Low Profile)

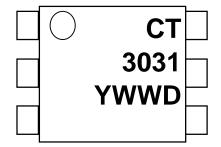




Recommended Solder Mask Dimensions in mm unless otherwise stated



Marking Information



Note:

CT: Logo

3031 : Part NumberY : Fiscal YearWW : Work Week

D : Manufacturing Code



Ordering Information

CT303X(Y)(Z)-G, CT304X(Y)(Z)-G, CT306X(Y)(Z)-G, CT308X(Y)(Z)-G

X = (1,2,3)

Y = Lead form option (S, SL, M or none)

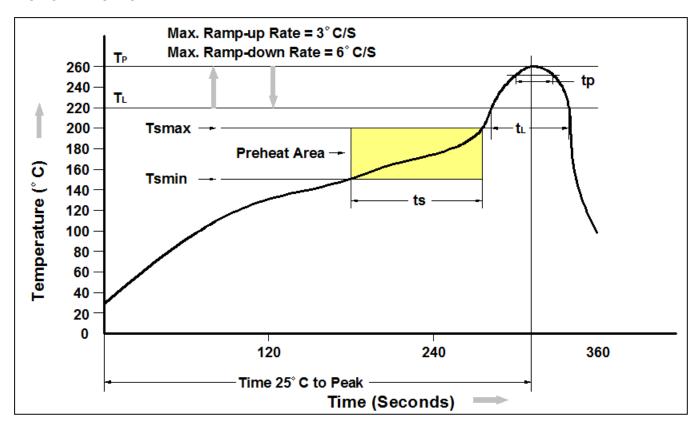
Z = Tape and reel option (TA, TB or none)

G= Material option (G: Green, None: Non-green)

Option	Description	Quantity	
None	None Standard 6 Pin Dip		
М	Wide Lead Forming	50Units/Tube	
S(TA)	Surface Mount Lead Forming – With Option A Taping	1000 Units/Reel	
S(TB)	Surface Mount Lead Forming – With Option B Taping	1000 Units/Reel	
SL(TA)	Surface Mount Lead Forming(Low Profile) – With Option A Taping	1000 Units/Reel	
SL(TB)	Surface Mount Lead Forming(Low Profile) – With Option B Taping	1000 Units/Reel	



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to tթ)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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